# **Excellent Integrated System Limited**

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Texas Instruments
LM334Z/NOPB

For any questions, you can email us directly: <a href="mailto:sales@integrated-circuit.com">sales@integrated-circuit.com</a>

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LM134, LM234, LM334

www.ti.com

SNVS746E - MARCH 2000-REVISED MAY 2013

# LM134/LM234/LM334 3-Terminal Adjustable Current Sources

Check for Samples: LM134, LM234, LM334

#### **FEATURES**

- Operates From 1V to 40V
- 0.02%/V Current Regulation
- Programmable From 1µA to 10mA
- **True 2-Terminal Operation**
- **Available as Fully Specified Temperature** Sensor
- ±3% Initial Accuracy

#### DESCRIPTION

The LM134/LM234/LM334 are 3-terminal adjustable current sources featuring 10,000:1 range in operating current, excellent current regulation and a wide dynamic voltage range of 1V to 40V. Current is established with one external resistor and no other parts are required. Initial current accuracy is ±3%. The LM134/LM234/LM334 are true floating current sources with no separate power supply connections. In addition, reverse applied voltages of up to 20V will draw only a few dozen microamperes of current, allowing the devices to act as both a rectifier and current source in AC applications.

The sense voltage used to establish operating current in the LM134 is 64mV at 25°C and is directly proportional to absolute temperature (°K). The simplest one external resistor connection, then, generates a current with ≈+0.33%/°C temperature dependence. Zero drift operation can be obtained by adding one extra resistor and a diode.

Applications for the current sources include bias networks, surge protection, low power reference, ramp generation, LED driver, and temperature sensing. The LM234-3 and LM234-6 are specified as true temperature sensors with ensured initial accuracy of  $\pm 3^{\circ}\text{C}$  and  $\pm 6^{\circ}\text{C}$ , respectively. These devices are ideal in remote sense applications because series resistance in long wire runs does not affect accuracy. In addition, only 2 wires are required.

The LM134 is specified over a temperature range of -55°C to +125°C, the LM234 from -25°C to +100°C and the LM334 from 0°C to +70°C. These devices are available in TO hermetic, TO-92 and SOIC-8 plastic packages.

#### **Connection Diagrams**

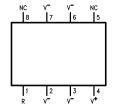


Figure 1. SOIC-8 Surface Mount Package (LM334M; LM334M/NOPB; LM334MX; LM334MX/NOPB) See Package Number D

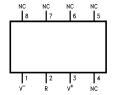


Figure 2. SOIC-8 Alternative Pinout Surface Mount **Package** (LM334SM; LM334SM/NOPB; LM334SMX; LM334SMX/NOPB) See Package Number D



Figure 3. TO Metal Can Package (Bottom View) See Package Number NDV



Figure 4. TO-92 Plastic Package (Bottom View) See Package Number LP

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. All trademarks are the property of their respective owners.



Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

## LM134, LM234, LM334



SNVS746E-MARCH 2000-REVISED MAY 2013

www.ti.com



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### Absolute Maximum Ratings(1)(2)

Absolute Maximum	- ratingo				
V <sup>+</sup> to V <sup>-</sup> Forward Voltage		LM134/LM234/LM334	40V		
		LM234-3/LM234-6	30V		
V <sup>+</sup> to V <sup>-</sup> Reverse Voltage			20V		
R Pin to V <sup>-</sup> Voltage			5V		
Set Current			10 mA		
Power Dissipation			400 mW		
ESD Susceptibility (3)			2000V		
Operating Temperature Ran	ige <sup>(4)</sup>	LM134	-55°C to +125°C		
		LM234/LM234-3/LM234-6	-25°C to +100°C		
		LM334	0°C to +70°C		
Soldering Information	TO-92 Package (10 sec.	)	260°C		
	TO Package (10 sec.)		300°C		
	SOIC Package	Vapor Phase (60 sec.)	215°C		
		Infrared (15 sec.)	220°C		

<sup>(1) &</sup>quot;Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits.

LM134 150°C LM234 125°C LM334 100°C

See Thermal Characteristics.

### **Thermal Characteristics**

over operating free-air temperature range (unless otherwise noted)

Thermal Resistance	TO-92	то	SOIC-8
$\theta_{ja}$ (Junction to Ambient)	180°C/W (0.4" leads)	440°C/W	165°C/W
	160°C/W (0.125" leads)		
$\theta_{jc}$ (Junction to Case)	N/A	32°C/W	80°C/W

Product Folder Links: LM134 LM234 LM334

Submit Documentation Feedback

Copyright © 2000-2013, Texas Instruments Incorporated

<sup>(2)</sup> If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

<sup>(3)</sup> Human body model, 100pF discharged through a  $1.5k\Omega$  resistor.

<sup>(4)</sup> For elevated temperature operation, T<sub>J</sub> max is:



Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LM134, LM234, LM334

www.ti.com

SNVS746E -MARCH 2000-REVISED MAY 2013

## Electrical Characteristics(1)

Barranatan	0	LN	1134/LM	234		l lmita			
Parameter	Conditions			Тур	Max	Min	Тур	Max	Units
Set Current Error, V <sup>+</sup> =2.5V <sup>(2)</sup>	10µA ≤ I <sub>SET</sub> ≤ 1mA				3			6	%
	1mA < I <sub>SET</sub> ≤ 5mA				5			8	%
	2μA ≤ I <sub>SET</sub> < 10μA				8			12	%
Ratio of Set Current to Bias	100μA ≤ I <sub>SET</sub> ≤ 1mA		14	18	23	14	18	26	
Current	1mA ≤ I <sub>SET</sub> ≤ 5mA		14			14			
	2 μA≤I <sub>SET</sub> ≤100 μA			18	23		18	26	
Minimum Operating Voltage	2μA ≤ I <sub>SET</sub> ≤ 100μA		0.8			0.8		V	
	100μA < I <sub>SET</sub> ≤ 1mA		0.9			0.9		V	
	1mA < I <sub>SET</sub> ≤ 5mA			1.0			1.0		V
Average Change in Set Current	2μA ≤ I <sub>SET</sub> ≤ 1mA	1.5 ≤ V <sup>+</sup> ≤ 5V		0.02	0.05		0.02	0.1	%/V
with Input Voltage		5V ≤ V <sup>+</sup> ≤ 40V		0.01	0.03		0.01	0.05	%/V
	1mA < I <sub>SET</sub> ≤ 5mA	1.5V ≤ V ≤ 5V		0.03			0.03		%/V
		5V ≤ V ≤ 40V		0.02			0.02		%/V
Temperature Dependence of Set Current <sup>(3)</sup>	25µA ≤ I <sub>SET</sub> ≤ 1mA		0.96T	Т	1.04T	0.96T	Т	1.04T	
Effective Shunt Capacitance				15			15		pF

- Unless otherwise specified, tests are performed at T<sub>i</sub> = 25°C with pulse testing so that junction temperature does not change during test
- Set current is the current flowing into the V<sup>+</sup> pin. For the Basic 2-Terminal Current Source circuit shown in Figure 13.  $I_{SET}$  is determined by the following formula:  $I_{SET} = 67.7 \text{ mV/R}_{SET}$  (@ 25°C). Set current error is expressed as a percent deviation from this amount.  $I_{SET}$  increases at 0.336%/°C @  $I_{j} = 25$ °C (227  $\mu$ V/°C).
- I<sub>SET</sub> is directly proportional to absolute temperature (°K). I<sub>SET</sub> at any temperature can be calculated from: I<sub>SET</sub> = I<sub>0</sub> (T/T<sub>0</sub>) where I<sub>0</sub> is I<sub>SET</sub> measured at To (°K).

#### Electrical Characteristics(1)

<b>D</b>	0			LM234-3	3		l luita		
Parameter	Condi	Min	Тур	Max	Min	Тур	Max	Units	
Set Current Error, V <sup>+</sup> =2.5V (2)	100μA ≤ I <sub>SET</sub> ≤ 1mA				±1			±2	%
	T <sub>J</sub> = 25°								
Equivalent Temperature Error					±3			±6	°C
Ratio of Set Current to Bias Current	100μA ≤ I <sub>SET</sub> ≤ 1mA		14	18	26	14	18	26	
Minimum Operating Voltage	100µA I <sub>SET</sub> ≤ 1mA			0.9			0.9		V
Average Change in Set Current	100μA ≤ I <sub>SET</sub> ≤ 1mA	1.5 ≤ V <sup>+</sup> ≤ 5V		0.02	0.05		0.02	0.01	%/V
with Input Voltage		5V ≤ V <sup>+</sup> ≤ 30V		0.01	0.03		18 26	%/V	
Temperature Dependence of Set Current <sup>(3)</sup>	100μA ≤ I <sub>SET</sub> ≤ 1mA		0.98T	Т	1.02T	0.97T	Т	1.03T	
Equivalent Slope Error					±2			±3	%
Effective Shunt Capacitance				15			15		pF

- Unless otherwise specified, tests are performed at  $T_j = 25^{\circ}\text{C}$  with pulse testing so that junction temperature does not change during test Set current is the current flowing into the V<sup>+</sup> pin. For the Basic 2-Terminal Current Source circuit shown in Figure 13.  $I_{SET}$  is determined by the following formula:  $I_{SET} = 67.7 \text{ mV/R}_{SET}$  (@ 25°C). Set current error is expressed as a percent deviation from this amount.  $I_{SET}$  increases at 0.336%/°C @  $T_j = 25^{\circ}\text{C}$  (227  $\mu$ V/°C).
- I<sub>SET</sub> is directly proportional to absolute temperature (°K). I<sub>SET</sub> at any temperature can be calculated from: I<sub>SET</sub> = I<sub>o</sub> (T/T<sub>o</sub>) where I<sub>o</sub> is I<sub>SET</sub> measured at To (°K).

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

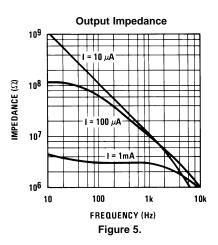
# LM134, LM234, LM334

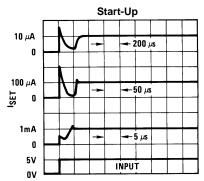


SNVS746E -MARCH 2000-REVISED MAY 2013

www.ti.com

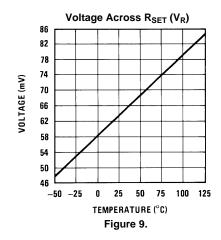
#### **Typical Performance Characteristics**

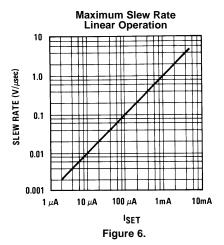


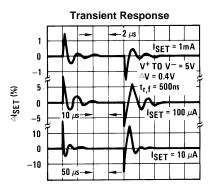


TIME (Note scale changes at each current level)

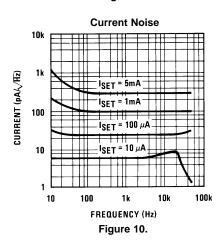
Figure 7.







TIME (Note scale changes for each current)
Figure 8.



Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

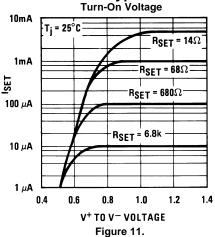


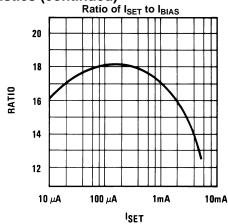
LM134, LM234, LM334

www.ti.com

SNVS746E -MARCH 2000-REVISED MAY 2013

# Typical Performance Characteristics (continued) Turn-On Voltage Ratio of





Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### LM134, LM234, LM334



SNVS746E -MARCH 2000-REVISED MAY 2013

www.ti.com

#### **APPLICATION HINTS**

The LM134 has been designed for ease of application, but a general discussion of design features is presented here to familiarize the designer with device characteristics which may not be immediately obvious. These include the effects of slewing, power dissipation, capacitance, noise, and contact resistance.

#### Calculating R<sub>SET</sub>

The total current through the LM134 ( $I_{SET}$ ) is the sum of the current going through the SET resistor ( $I_R$ ) and the LM134's bias current ( $I_{BIAS}$ ), as shown in Figure 13.

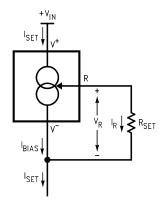


Figure 13. Basic Current Source

A graph showing the ratio of these two currents is supplied under **Ratio of I<sub>SET</sub> to I<sub>BIAS</sub>** in Typical Performance Characteristics. The current flowing through R<sub>SET</sub> is determined by V<sub>R</sub>, which is approximately 214 $\mu$ V/°K (64 mV/298°K ~ 214 $\mu$ V/°K).

$$I_{SET} = I_R + I_{BIAS} = \frac{V_R}{R_{SET}} + I_{BIAS}$$
 (1)

Since (for a given set current) I<sub>BIAS</sub> is simply a percentage of I<sub>SET</sub>, the equation can be rewritten

$$I_{SET} = \left(\frac{V_R}{R_{SET}}\right) \left(\frac{n}{n-1}\right)$$

where

• n is the ratio of I<sub>SET</sub> to I<sub>BIAS</sub> as specified in Electrical Characteristics and shown in the graph (2)

Since n is typically 18 for  $2\mu A \le I_{SET} \le 1 mA$ , the equation can be further simplified to

$$I_{SET} = \left(\frac{V_{R}}{R_{SET}}\right) (1.059) = \frac{227 \ \mu V/^{\circ} K}{R_{SET}}$$
 (3)

for most set currents.

#### **Slew Rate**

At slew rates above a given threshold (see curve), the LM134 may exhibit non-linear current shifts. The slewing rate at which this occurs is directly proportional to  $I_{SET}$ . At  $I_{SET}=10\mu\text{A}$ , maximum dV/dt is 0.01V/ $\mu$ s; at  $I_{SET}=10\mu\text{A}$ , the limit is 1V/ $\mu$ s. Slew rates above the limit do not harm the LM134, or cause large currents to flow.

#### **Thermal Effects**

Internal heating can have a significant effect on current regulation for  $I_{SET}$  greater than 100µA. For example, each 1V increase across the LM134 at  $I_{SET} = 1$  mA will increase junction temperature by  $\approx 0.4$ °C in still air. Output current ( $I_{SET}$ ) has a temperature coefficient of  $\approx 0.33$ %/°C, so the change in current due to temperature rise will be (0.4) (0.33) = 0.132%. This is a 10:1 degradation in regulation compared to true electrical effects. Thermal effects, therefore, must be taken into account when DC regulation is critical and  $I_{SET}$  exceeds 100µA. Heat sinking of the TO package or the TO-92 leads can reduce this effect by more than 3:1.

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LM134, LM234, LM334

www.ti.com

SNVS746E -MARCH 2000-REVISED MAY 2013

#### **Shunt Capacitance**

In certain applications, the 15 pF shunt capacitance of the LM134 may have to be reduced, either because of loading problems or because it limits the AC output impedance of the current source. This can be easily accomplished by buffering the LM134 with an FET as shown in the applications. This can reduce capacitance to less than 3 pF and improve regulation by at least an order of magnitude. DC characteristics (with the exception of minimum input voltage), are not affected.

#### **Noise**

Current noise generated by the LM134 is approximately 4 times the shot noise of a transistor. If the LM134 is used as an active load for a transistor amplifier, input referred noise will be increased by about 12dB. In many cases, this is acceptable and a single stage amplifier can be built with a voltage gain exceeding 2000.

#### **Lead Resistance**

The sense voltage which determines operating current of the LM134 is less than 100mV. At this level, thermocouple or lead resistance effects should be minimized by locating the current setting resistor physically close to the device. Sockets should be avoided if possible. It takes only  $0.7\Omega$  contact resistance to reduce output current by 1% at the 1 mA level.

#### **Sensing Temperature**

The LM134 makes an ideal remote temperature sensor because its current mode operation does not lose accuracy over long wire runs. Output current is directly proportional to absolute temperature in degrees Kelvin, according to the following formula:

$$I_{SET} = \frac{(227 \,\mu\text{V/°K}) \,(\text{T})}{\text{R}_{SET}} \tag{4}$$

Calibration of the LM134 is greatly simplified because of the fact that most of the initial inaccuracy is due to a gain term (slope error) and not an offset. This means that a calibration consisting of a gain adjustment only will trim both slope and zero at the same time. In addition, gain adjustment is a one point trim because the output of the LM134 extrapolates to zero at  $0^{\circ}$ K, independent of  $R_{SET}$  or any initial inaccuracy.

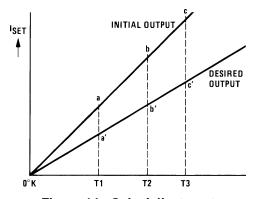


Figure 14. Gain Adjustment

This property of the LM134 is illustrated in the accompanying graph. Line abc is the sensor current before trimming. Line a'b'c' is the desired output. A gain trim done at T2 will move the output from b to b' and will simultaneously correct the slope so that the output at T1 and T3 will be correct. This gain trim can be done on  $R_{\text{SET}}$  or on the load resistor used to terminate the LM134. Slope error after trim will normally be less than ±1%. To maintain this accuracy, however, a low temperature coefficient resistor must be used for  $R_{\text{SET}}$ .

A 33 ppm/°C drift of  $R_{SET}$  will give a 1% slope error because the resistor will normally see about the same temperature variations as the LM134. Separating  $R_{SET}$  from the LM134 requires 3 wires and has lead resistance problems, so is not normally recommended. Metal film resistors with less than 20 ppm/°C drift are readily available. Wire wound resistors may also be used where best stability is required.

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

## LM134, LM234, LM334



SNVS746E -MARCH 2000-REVISED MAY 2013

www.ti.com

#### **Application as a Zero Temperature Coefficent Current Source**

Adding a diode and a resistor to the standard LM134 configuration can cancel the temperature-dependent characteristic of the LM134. The circuit shown in Figure 15 balances the positive tempoo of the LM134 (about +0.23 mV/°C) with the negative tempoo of a forward-biased silicon diode (about -2.5 mV/°C).

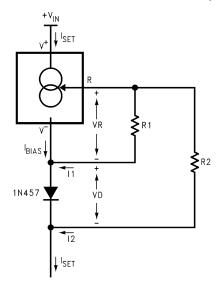


Figure 15. Zero Tempco Current Source

The set current ( $I_{SET}$ ) is the sum of  $I_1$  and  $I_2$ , each contributing approximately 50% of the set current, and  $I_{BIAS}$ .  $I_{BIAS}$  is usually included in the  $I_1$  term by increasing the  $V_R$  value used for calculations by 5.9%. (See **CALCULATING**  $R_{SET}$ .)

$$I_{SET} = I_1 + I_2 + I_{BIAS}$$
, where  $I_1 = \frac{V_R}{R_1}$  and  $I_2 = \frac{V_R + V_D}{R_2}$  (5)

The first step is to minimize the tempco of the circuit, using the following equations. An example is given using a value of  $+227\mu\text{V/°C}$  as the tempco of the LM134 (which includes the I<sub>BIAS</sub> component), and -2.5 mV/°C as the tempco of the diode (for best results, this value should be directly measured or obtained from the manufacturer of the diode).

$$\begin{split} I_{\text{SET}} &= I_1 + I_2 \\ \frac{dI_{\text{SET}}}{dT} &= \frac{dI_1}{dT} + \frac{dI_2}{dT} \\ &\approx \frac{227 \,\mu\text{V/°C}}{R_1} + \frac{227 \,\mu\text{V/°C} - 2.5 \,\text{mV/°C}}{R_2} \\ &= 0 \,(\text{solve for tempco} = 0) \end{split} \tag{6}$$

$$\frac{R_2}{R_1} \approx \frac{2.5 \,\text{mV/°C} - 227 \,\mu\text{V/°C}}{227 \,\mu\text{V/°C}} \approx 10.0 \end{split}$$

With the  $R_1$  to  $R_2$  ratio determined, values for  $R_1$  and  $R_2$  should be determined to give the desired set current. The formula for calculating the set current at T = 25°C is shown below, followed by an example that assumes the forward voltage drop across the diode ( $V_D$ ) is 0.6V, the voltage across  $R_1$  is 67.7mV (64 mV + 5.9% to account for  $I_{BIAS}$ ), and  $R_2/R_1$  = 10 (from the previous calculations).

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LM134, LM234, LM334

www.ti.com

SNVS746E - MARCH 2000-REVISED MAY 2013

$$\begin{split} I_{SET} &= I_1 + I_2 + I_{BIAS} \\ &= \frac{V_R}{R_1} + \frac{V_R + V_D}{R_2} \\ &\approx \frac{67.7 \text{ mV}}{R_1} + \frac{67.7 \text{ mV} + 0.6 \text{V}}{10.0 \text{ R}_1} \\ I_{SET} &\approx \frac{0.134 \text{V}}{R_1} \end{split}$$

This circuit will eliminate most of the LM134's temperature coefficient, and it does a good job even if the estimates of the diode's characteristics are not accurate (as the following example will show). For lowest tempco with a specific diode at the desired  $I_{SET}$ , however, the circuit should be built and tested over temperature. If the measured tempco of  $I_{SET}$  is positive,  $R_2$  should be reduced. If the resulting tempco is negative,  $R_2$  should be increased. The recommended diode for use in this circuit is the 1N457 because its tempco is centered at 11 times the tempco of the LM134, allowing  $R_2$  = 10  $R_1$ . You can also use this circuit to create a current source with non-zero tempcos by setting the tempco component of the tempco equation to the desired value instead of 0.

EXAMPLE: A 1mA, Zero-Tempco Current Source

First, solve for  $R_1$  and  $R_2$ :

$$I_{SET} \approx 1 \text{ mA} = \frac{0.134 \text{ V}}{R_1}$$
 $R_2 = 134 \Omega = 10 R_1$ 
 $R_2 = 1340 \Omega$  (9)

The values of  $R_1$  and  $R_2$  can be changed to standard 1% resistor values ( $R_1 = 133\Omega$  and  $R_2 = 1.33k\Omega$ ) with less than a 0.75% error.

If the forward voltage drop of the diode was 0.65V instead of the estimate of 0.6V (an error of 8%), the actual set current will be

$$I_{SET} = \frac{67.7 \text{ mV}}{R_1} + \frac{67.7 \text{ mV} + 0.65 \text{V}}{R_2}$$

$$= \frac{67.7 \text{ mV}}{133} + \frac{67.7 \text{ mV} + 0.65 \text{V}}{1330}$$

$$= 1.049 \text{ mA}$$
(10)

an error of less than 5%.

If the estimate for the tempco of the diode's forward voltage drop was off, the tempco cancellation is still reasonably effective. Assume the tempco of the diode is 2.6mV/°C instead of 2.5mV/°C (an error of 4%). The tempco of the circuit is now:

$$\begin{split} \frac{\text{dI}_{\text{SET}}}{\text{dT}} &= \frac{\text{dI}_{1}}{\text{dT}} + \frac{\text{dI}_{2}}{\text{dT}} \\ &= \frac{227 \ \mu\text{V}/^{\circ}\text{C}}{133\Omega} + \frac{227 \ \mu\text{V}/^{\circ}\text{C} - 2.6 \ \text{mV}/^{\circ}\text{C}}{1330\Omega} \\ &= -77 \ \text{nA}/^{\circ}\text{C} \end{split} \tag{11}$$

A 1mA LM134 current source with no temperature compensation would have a set resistor of  $68\Omega$  and a resulting tempco of

$$\frac{227 \ \mu \text{V/}^{\circ}\text{C}}{68\Omega} = 3.3 \ \mu \text{A/}^{\circ}\text{C}$$
 (12)

So even if the diode's tempco varies as much as  $\pm 4\%$  from its estimated value, the circuit still eliminates 98% of the LM134's inherent tempco.

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

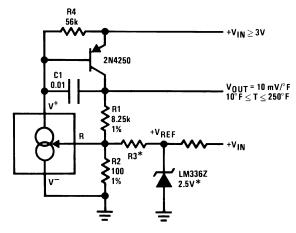
## LM134, LM234, LM334



SNVS746E -MARCH 2000-REVISED MAY 2013

www.ti.com

### **Typical Applications**



\*Select R3 =  $V_{REF}$ /583 $\mu$ A.  $V_{REF}$  may be any stable positive voltage  $\geq$  2V Trim R3 to calibrate

Figure 16. Ground Referred Fahrenheit Thermometer

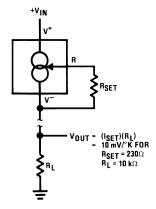
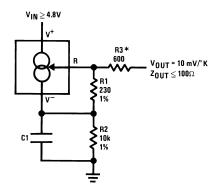


Figure 17. Terminating Remote Sensor for Voltage Output



\*Output impedance of the LM134 at the "R" pin is approximately  $\frac{-R_2}{4\pi}$ 

where  $R_2$  is the equivalent external resistance connected from the  $V^-$  pin to ground. This negative resistance can be reduced by a factor of 5 or more by inserting an equivalent resistor  $R_3 = (R_2/16)$  in series with the output.

Figure 18. Low Output Impedance Thermometer

Submit Documentation Feedback

Copyright © 2000–2013, Texas Instruments Incorporated



LM134, LM234, LM334

www.ti.com

SNVS746E - MARCH 2000-REVISED MAY 2013

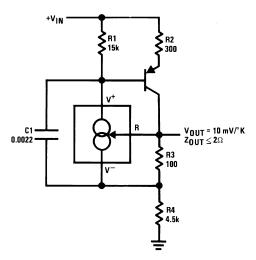
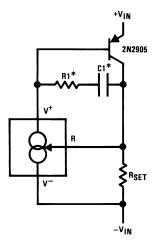


Figure 19. Low Output Impedance Thermometer



\*Select R1 and C1 for optimum stability

Copyright © 2000-2013, Texas Instruments Incorporated

Figure 20. Higher Output Current

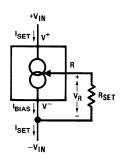


Figure 21. Basic 2-Terminal Current Source

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

LM134, LM234, LM334



SNVS746E -MARCH 2000-REVISED MAY 2013

www.ti.com

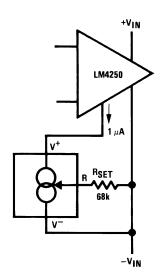


Figure 22. Micropower Bias

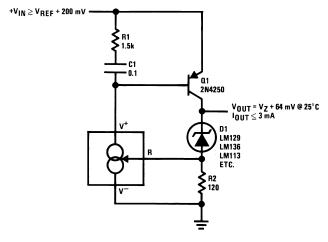


Figure 23. Low Input Voltage Reference Driver

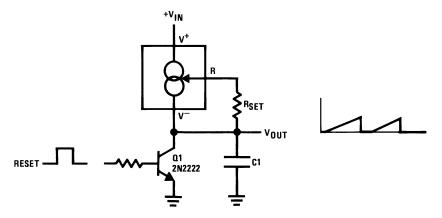


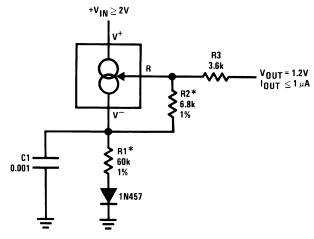
Figure 24. Ramp Generator

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

LM134, LM234, LM334

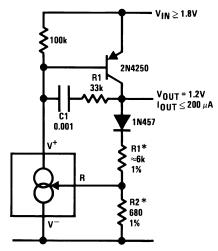
www.ti.com

SNVS746E - MARCH 2000-REVISED MAY 2013



\*Select ratio of R1 to R2 to obtain zero temperature drift

Figure 25. 1.2V Reference Operates on 10 µA and 2V



\*Select ratio of R1 to R2 for zero temperature drift

Figure 26. 1.2V Regulator with 1.8V Minimum Input

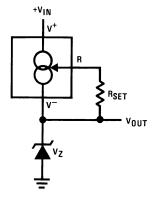


Figure 27. Zener Biasing

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

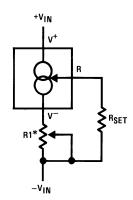
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

# LM134, LM234, LM334



SNVS746E -MARCH 2000-REVISED MAY 2013

www.ti.com



\*For ±10% adjustment, select R<sub>SET</sub>10% high, and make R1  $\approx$  3 R<sub>SET</sub>

Figure 28. Alternate Trimming Technique

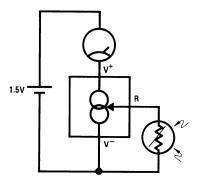
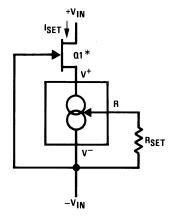


Figure 29. Buffer for Photoconductive Cell



Product Folder Links: LM134 LM234 LM334

\*Select Q1 or Q2 to ensure at least 1V across the LM134.  $V_p$  (1 -  $I_{SET}/I_{DSS}$ )  $\geq$  1.2V.

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LM134, LM234, LM334

www.ti.com

SNVS746E -MARCH 2000-REVISED MAY 2013

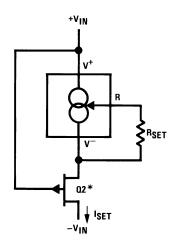
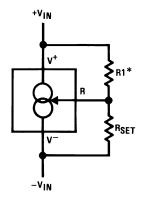
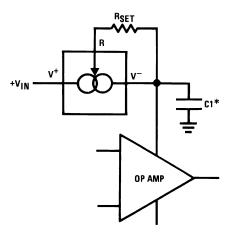


Figure 30. FET Cascoding for Low Capacitance and/or Ultra High Output Impedance



\* $Z_{OUT} \approx -16 \cdot R1 (R1/V_{IN} \text{ must not exceed } I_{SET})$ 

Figure 31. Generating Negative Output Impedance



\*Use minimum value required to ensure stability of protected device. This minimizes inrush current to a direct short.

Figure 32. In-Line Current Limiter

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

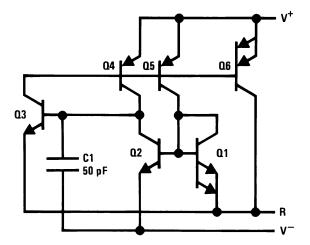
# LM134, LM234, LM334



SNVS746E -MARCH 2000-REVISED MAY 2013

www.ti.com

#### **Schematic Diagram**





Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3



	*
_ <i>ii</i>	Texas
<u> </u>	IEAAS
•	INSTRUMENTS

LM134,	LM234,	LM334
--------	--------	-------

www.ti.com

SNVS746E -MARCH 2000-REVISED MAY 2013

#### **REVISION HISTORY**

Changes from Revision C (April 2013) to Revision D								
•	Changed layout of National Data Sheet to TI format	. 16						



Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

27-Jul-2016

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Sample
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LM134 MDC	ACTIVE	DIESALE	Y	0	400	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	-40 to 85		Sample
LM134H	ACTIVE	ТО	NDV	3	1000	TBD	Call TI	Call TI	-55 to 125	( LM134H ~ LM134H)	Sample
LM134H/NOPB	ACTIVE	то	NDV	3	1000	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	-55 to 125	( LM134H ~ LM134H)	Sample
LM234Z-3/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-25 to 100	LM234 Z-3	Sample
LM234Z-6/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-25 to 100	LM234 Z-6	Sample
LM334 MWC	ACTIVE	WAFERSALE	YS	0	1	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	-40 to 85		Sample
LM334M	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	0 to 70	LM334 M	
LM334M/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM334 M	Sampl
LM334MX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM334 M	Sampl
LM334SM	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	0 to 70	LM334 SM	
LM334SM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM334 SM	Sampl
LM334SMX	NRND	SOIC	D	8	2500	TBD	Call TI	Call TI	0 to 70	LM334 SM	
LM334SMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM334 SM	Samp
LM334Z/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		LM334 Z	Samp
LM334Z/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	0 to 70	LM334 Z	Samp

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

Addendum-Page 1



#### Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

27-Jul-2016

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): Til defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

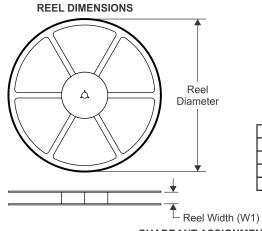
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

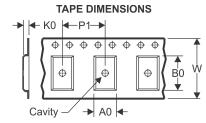


## **PACKAGE MATERIALS INFORMATION**

www.ti.com 5-Dec-2014

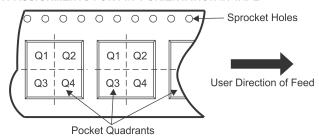
#### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM334MX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM334SMX	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM334SMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

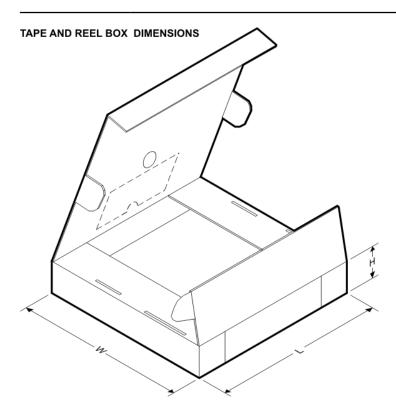
Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



# **PACKAGE MATERIALS INFORMATION**

www.ti.com 5-Dec-2014



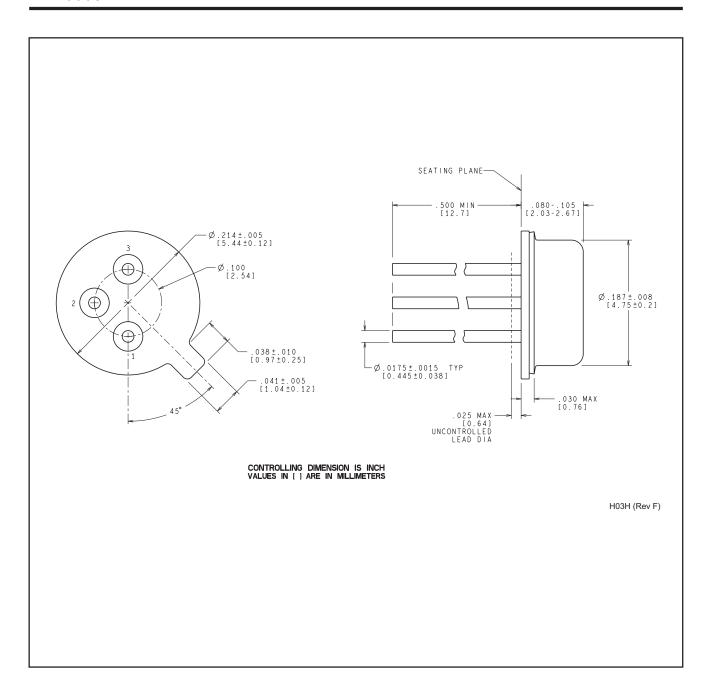
#### \*All dimensions are nominal

7 til dillionolollo dio nominal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM334MX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM334SMX	SOIC	D	8	2500	367.0	367.0	35.0
LM334SMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0





# NDV0003H

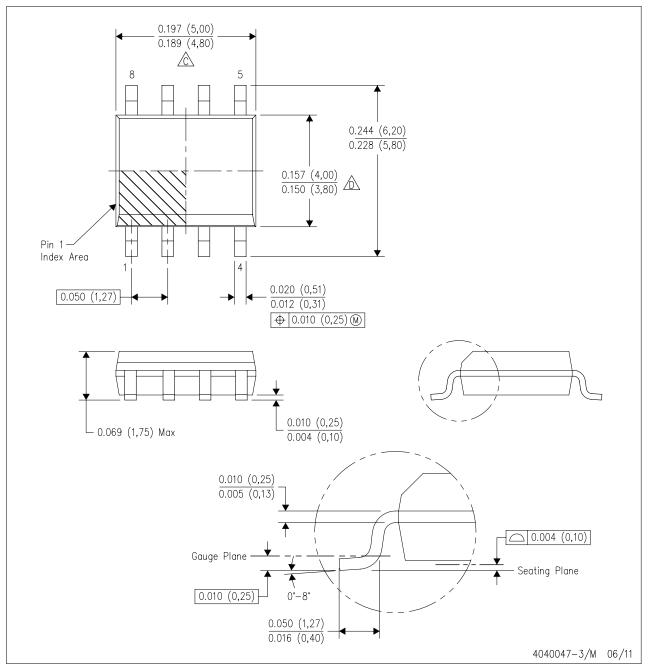






# D (R-PDSO-G8)

## PLASTIC SMALL OUTLINE

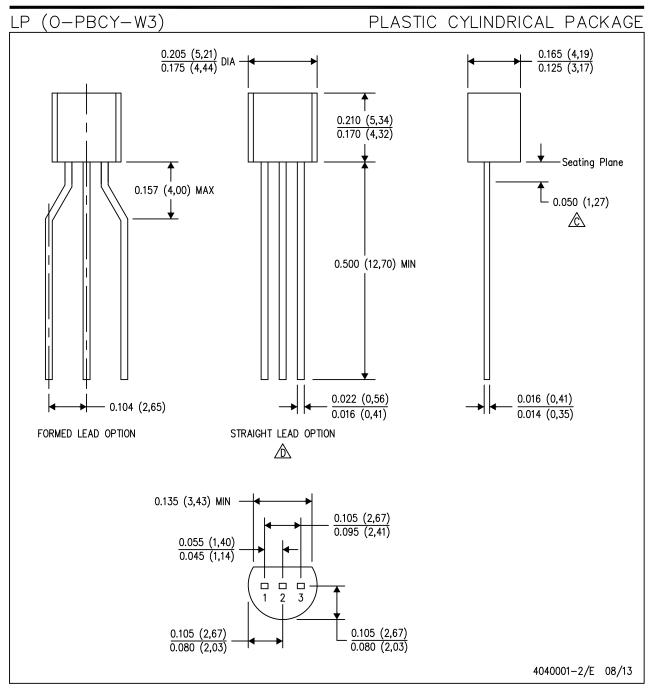


NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.







NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Lead dimensions are not controlled within this area.

 $\stackrel{f hinspace}{f hinspace}$  Falls within JEDEC TO-226 Variation AA (TO-226 replaces TO-92).

E. Shipping Method:

Straight lead option available in bulk pack only.

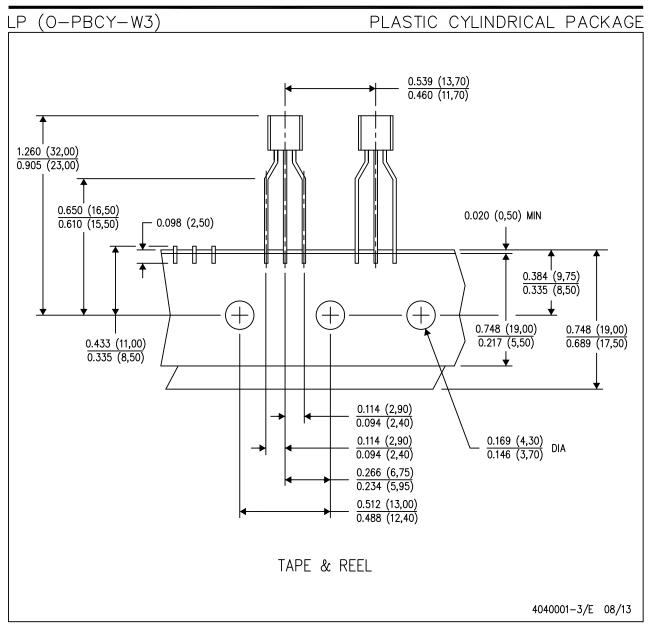
Formed lead option available in tape & reel or ammo pack.

Specific products can be offered in limited combinations of shipping mediums and lead options.

Consult product folder for more information on available options.







NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Tape and Reel information for the Formed Lead Option package.





Datasheet of LM334Z/NOPB - IC CURRENT SOURCE 3% TO92-3

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have not been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

#### **Applications**

**Products** Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive **Amplifiers** amplifier.ti.com Communications and Telecom www.ti.com/communications Computers and Peripherals **Data Converters** dataconverter.ti.com www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Security www.ti.com/security

Power Mgmt Space, Avionics and Defense www.ti.com/space-avionics-defense power.ti.com

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

Logic

**OMAP Applications Processors TI E2E Community** www.ti.com/omap e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity

> Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2016, Texas Instruments Incorporated